



Material Content Data Sheet



Halogen-Free

Sales Product Name TLE9872QXA40

Issued

08. February 2022

MA# MA004156010

Package PG-VQFN-48-29

Weight*

130.34 mg

Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	5.492	4.21	4.21	42141	42141
leadframe	inorganic material	phosphorus	7723-14-0	0.018	0.01		137	
	non noble metal	zinc	7440-66-6	0.072	0.06		550	
	non noble metal	iron	7439-89-6	1.433	1.10		10996	
	non noble metal	copper	7440-50-8	58.193	44.64	45.81	446483	458166
wire	noble metal	gold	7440-57-5	0.789	0.61	0.61	6057	6057
encapsulation	organic material	carbon black	1333-86-4	0.179	0.14		1376	
	plastics	epoxy resin	-	7.594	5.83		58263	
	inorganic material	silicondioxide	60676-86-0	52.020	39.91	45.88	399121	458760
leadfinish	non noble metal	tin	7440-31-5	2.596	1.99	1.99	19921	19921
plating	noble metal	silver	7440-22-4	0.614	0.47	0.47	4710	4710
glue	plastics	epoxy resin	-	0.307	0.24		2356	
	noble metal	silver	7440-22-4	1.028	0.79	1.03	7889	10245
*deviation	< 10%	Sum in total:				100.00		1000000

Important Remarks:

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